

Features

- Interdigitated amplifying gates
- Fast turn-on and high di/dt
- Low switching losses

Typical Applications

- Inductive heating
- Electronic welders
- Self-commutated inverters

I_{T(AV)}	2160A
V_{DRM/V_{RRM}}	1900~2500V
t_q	40~80μs
I_{TSM}	23 kA
I²t	2645 10³A²S



SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _J (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Double side cooled,	125			2160	A
V _{DRM} V _{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	tp=10ms	125	1900		2500	V
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			160	mA
I _{TSM}	Surge on-state current	10ms half sine wave V _R =0.6V _{RRM}	125			23	kA
I ² t	I ² t for fusing coordination					2645	A ² s*10 ³
V _{TO}	Threshold voltage		125			1.48	V
r _T	On-state slope resistance					0.23	mΩ
V _{TM}	Peak on-state voltage	I _{TM} =4000A, F=35kN	125			2.40	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =0.67V _{DRM}	125			500	V/μs
di/dt	Critical rate of rise of on-state current	V _{DM} = 67%V _{DRM} to 3000A Gate pulse t _r ≤0.5μs I _{GM} =1.5A	125			1200	A/μs
Q _{rr}	Recovery charge	I _{TM} =2000A, tp=2000μs, di/dt=-60A/μs, V _R =50V	125		1400		μC
t _q	Circuit commutated turn-off time	I _{TM} =2000A, tp=2000μs, V _R =50V dv/dt=30V/μs, di/dt=-60A/μs	125	40		80	μs
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25	40		450	mA
V _{GT}	Gate trigger voltage			0.9		4.5	V
I _H	Holding current			20		1000	mA
V _{GD}	Non-trigger gate voltage	V _{DM} =67%V _{DRM}	125	0.3			V
R _{th(j-c)}	Thermal resistance Junction to case	DC double side cooled Clamping force 35kN				0.012	°C/W
R _{th(c-h)}	Thermal resistance case to heat sink					0.003	
F _m	Mounting force			30		40	kN
T _{stg}	Stored temperature			-40		140	°C
W _t	Weight				880		g
Outline		P15					

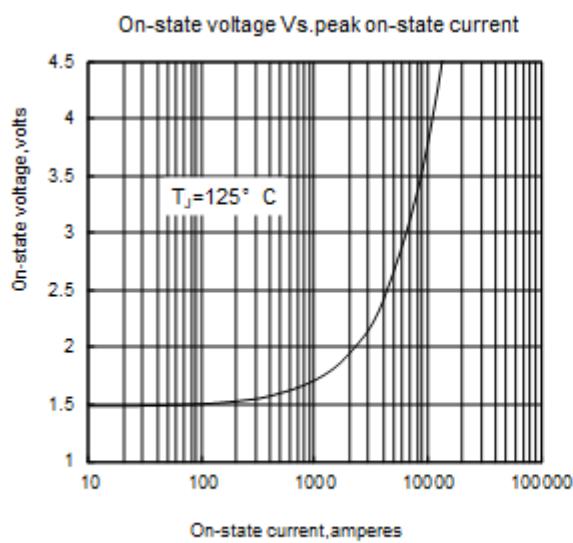


Fig1

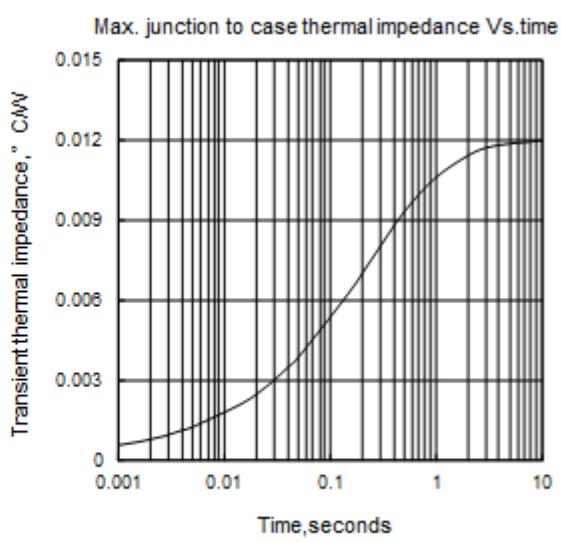


Fig2

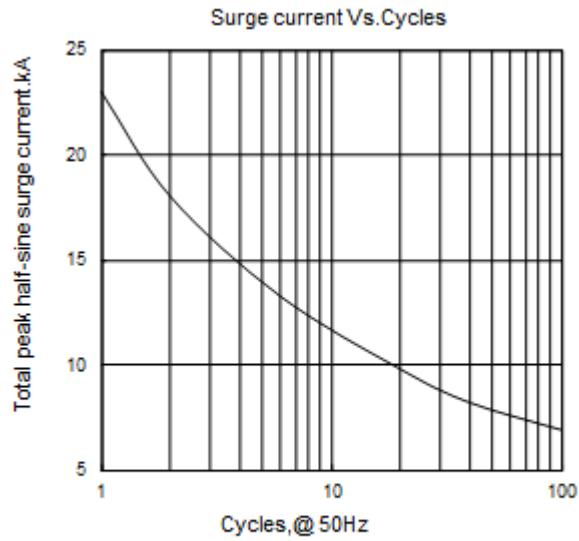


Fig3

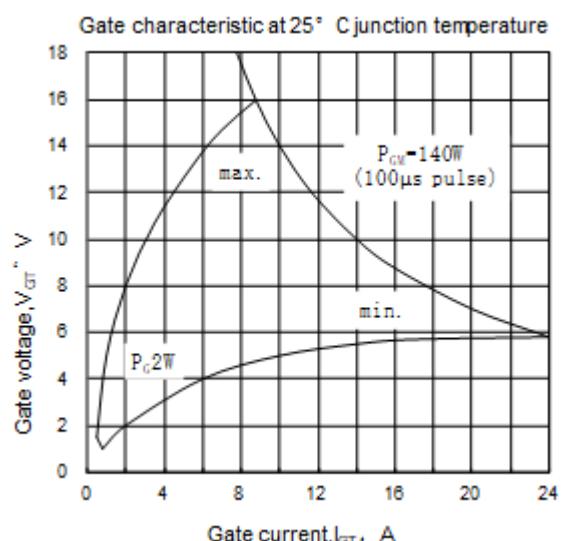


Fig4

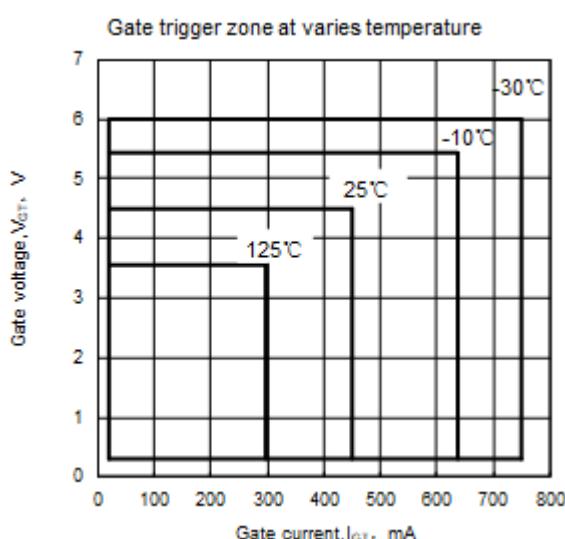


Fig5

